

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

12	SUBMISSION OF SECOND SUBSTITUTE SPECIFICATION			
~ .	THIN FILM TRANSISTORS)	adum Stanper	
	AT LEAST FIRST AND SECOND)	Alexandria, VA 22313-1450, on <u>11. 30.05</u>	
For:	SEMICONDUCTOR DEVICE HAVING)	Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450,	
Filed	June 29, 1999)	being deposited with the United States Postal Service with sufficient postage as First Class	
Seria	I No. 09/342,235)	CERTIFICATE OF MAILING I hereby certify that this correspondence is	
Yasu	hiko TAKEMURA)	Examiner: A. Sefer	
In re	Patent Application of:)	Group Art Unit: 2826	

Honorable Commissioner of Patents P.O. Box 1450

Alexandria, VA 22313-1450

Dear Sir:

Applicants submit herewith a substitute specification which corrects minor typographical and grammatical matters. The enclosed substitute specification does not include any new matter. Also enclosed is the marked-up copy of the specification showing changes with respect to the English-language translation of the application that is being filed concurrently.

Should there be any question with respect to the substitute specification, the Examiner is respectfully requested to contact the undersigned.

Respectfully submitted,

Eric J. Robinson

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